FORM PTO-1595 U.S. DEPARTMENT OF COMMERCE 1-31-92	08-31-2	001	Patent and Trademark Office	
R 7217/65196				
To the Honorable Commissioner of Patents and Trademark		 .	nereof.	
Name of conveying party(ies):	1018300	J14	party(ies):	
Nobuo Hareyama	[21/01 Name:	Sony Corporation	FT - PT	
Aditional name(s) of conveying party(ies) attached?		Address.	/934 /934	
3. Nature of Conveyance:	Straat	Address: 7-35 Kitashinagaw	50 1	
Assignment		Shinagawa-ku, Tokyo	, Japan	
Security Agreement Change	of Name City	State	ZIP	
Other Execution Date:	Additio	nal name(s) & address(es) a	attached? Yes X No	
4. Application number(s) or patent number(s):				
If this document is being filed together with a new applicat A. Patent Application No.(s)	,	plication is July 31,2001 tent No.(s)		
03/93440	3 □	Yes 🛛 No		
5. Name and address of party to whom correspondence			.,	
concerning document should be mailed:	6. 1012	al number of applications an	nd patents involved:	
Name: Jay H. Maioli Internal Address: Cooper & Dunham LLP	7. Total	I fee (37 CFR 3.41):	\$ 40.00	
		X Enclosed		
		Authorized to be char	rged to deposit account	
Street Address: 1185 Avenue of the Americas	8. Dep	osit account number:		
		-3125	if paying by deposit account)	
City: New York State: New York ZIP 1003		duplicate copy of this page	if paying by deposit account)	
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9. Statement and signature.				
To the best of my knowledge and belief, the original document.	o forgeping information is t	rue and correct and an	y attached copy is a true copy	
Jay H. Maioli, Reg. No.27,213 Name of Person Signing Signifure	Warde August 21 Da	1, 2001 ate		
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PATENT REEL: 012114 FRAME: 0375

Docket	Number:	7217/65196

ASSIGNMENT

WHEREAS, I, as a below named inventor, residing at the address stated next to my name, am a sole inventor (if only one name is listed below) or a joint inventor (if plural names are listed below) of certain new and useful improvements in MATCHING APPARATUS

for which application for Letters Patent of the United States of America was executed by me on the date indicated next to my name and address;

AND WHEREAS, Sony Corporation, a Japanese corporation with offices at 7-35 Kitashinagawa 6-Chome, Shinagawa-Ku, Tokyo, Japan (hereinafter referenced as ASSIGNEE) is desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries;

NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEE, its successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEE, as the assignee of the whole right, title and interest thereto;

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto;

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters Patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require and prepare at its own expense;

And I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto;

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

And I hereby authorize and request my attorney(s) of record in this applic	cation to insert the serial number and filing date of
And I hereby authorize and request my attorney(s) of record in this application in the spaces that follow: Serial Number:	, Thing Date
This assignment executed on the dates indicated below.	
NOBUO HAREYAMA	Execution date of U.S. Patent Application
Name of first or sole inventor	Diceation 150
KANAGAWA, JAPAN	
Residence of first or sole inventor Nabus Vapegania: Signature of first or sole inventor	July 31, 2001 Date of this assignment

RECORDED: 08/21/2001

PATENT REEL: 012114 FRAME: 0376